

INDUSTRIAL FEATURE

Design Featured at the Qt World Summit in Berlin

The Qt Company hosted the Qt World Summit, an annual gathering of the Qt ecosystem, earlier this month in Berlin, Germany. This year's event, which was held at the Berlin Congress Center Nov. 4-6, featured industry keynotes from Google, Trend Micro, and web psychologist Nathalie Nahai, among others.

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DEV KIT & OS NEWS

Nordic Semiconductor unveils dual Arm Cortex-M33 processor, wireless SoC for IoT applications

Nordic Semiconductor released the nRF5340 high-end multi-protocol System-on-Chip (SoC), the first member of its next generation of nRF5 Series SoCs, the company announced in a press release.

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POWER ELECTRONICS NEWS

Eurotech Announces the DynaCOR 40-35 Rugged NAS HPEC System

Eurotech, a long-time leading provider of embedded, Edge AI and general

purpose HPEC systems and a global leader in Internet of Things (IoT) enablement, has added the DynaCOR 40-35 to its High Performance Embedded Computing (HPEC) product portfolio.

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AUTOMOTIVE NEWS

AUTERA AutoBox ? Developing Automated Driving System Software

dSPACE now introduces the AUTERA product family, which will provide developers and test drivers with a complete product portfolio that supports the development of functions for automated driving by means of high computation power, high bandwidth, and abundant storage.

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MACHINE LEARNING NEWS

Actinius Cellular IoT Prototyping Platform Compatible with Adafruit FeatherWing

The 50.8 x 22.8mm Actinius Icarus IoT Board retails for around \$100 and employs a Nordic Semiconductor nRF9160 System-in-Package (SiP); a 64MHz Arm Cortex-M33 processor supported by 1MB of Flash.

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WEBCAST

Technologies Driving IoT Acceleration

Sponsored by: **Sierra Wireless**

Date: **November 21, 11:00 a.m. ET**

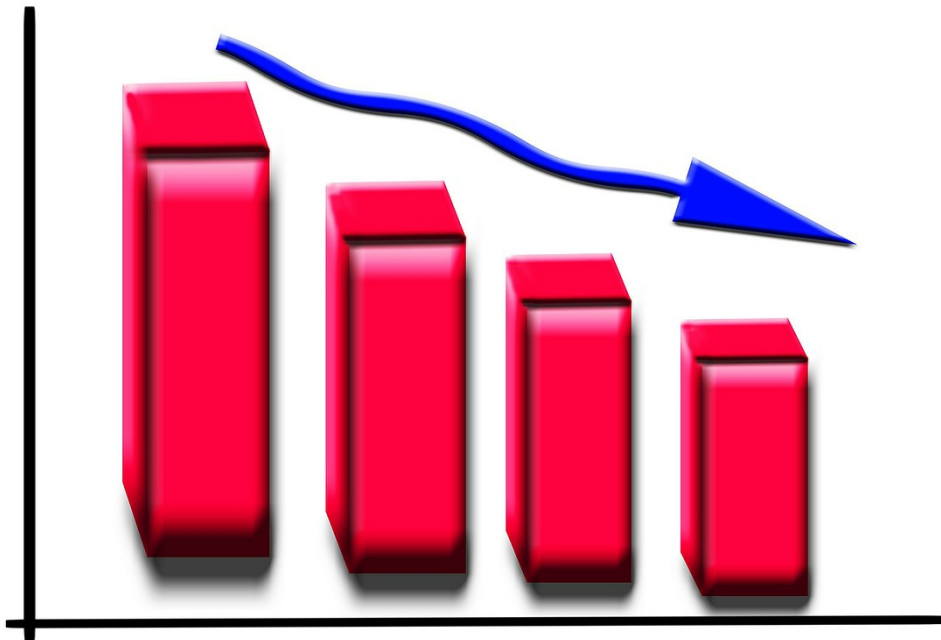
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INDUSTRIAL FEATURE

Silicon Wafer Area Shipments Fall for Fourth Consecutive Quarter

For the fourth consecutive quarter, starting from Q3 of 2018, worldwide silicon wafer area shipments have declined. The decline from Q2 to Q3 (2019) was not drastic, but a decline nevertheless. The drop from 2,983 million square inches shipped in Q2 to 2,932 million square inches in Q3 is approximately 1.7%.

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